PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Xpplication

Wushing Yin, et al.

AMPication No.

10/636,105

Filed

August 7, 2003

Confirmation No.

9143

INTEGRATED UNDERFILL PROCESS FOR BUMPED

CHIP ASSEMBLY

Examiner

Donghai D. Nguyen

Attorney's Docket

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on 7-29-05

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STATUS LETTER

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Further to the filing of the above-identified application on August 7, 2003, information is requested as to the present status of the above-identified application.

Respectfully submitted,

Victor B. Lebovici

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